# **YIDONG REN**

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428 S. Shaw Lane, East Lansing, MI - 48824, USA

#### RESEARCH INTERESTS

- Low-power Wireless Networks: Physical layer encoder decoder design [MobiSys'24, MobiCom'24 C3, MobiHoc'23, ICLR'23 ML4IoT]. Ultra-low power (backscatter) communication [INFOCOM'23].
- Internet of Things: Satellite IoT in rural areas [MobiCom'24 C1]. Cross-soil agricultural IoT [MobiCom'24 C2].
- Mobile Computing: Wearable system [SenSys'24]. Channel adapted Wi-Fi [TMC'22].

### **EDUCATION**

Michigan State University

East Lansing, USA

Ph.D. Candidate, Department of Computer Science and Engineering

2021 - Present

Advisor: Zhichao Cao

University of Electronic Science and Technology of China

Chengdu, China

B.E., Electronic and Information Engineering

2017 - 2021

#### **CONFERENCE PUBLICATIONS**

MobiCom 2024 [C1] SateRIoT: High-performance Ground-Space Networking for Rural IoT.

Yidong Ren, Amalinda Gamage, Li Liu, Mo Li, Shigang Chen, Younsuk Dong, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiCom 2024 [C2] Demeter: Reliable Cross-soil LPWAN with Low-cost Signal Polarization Alignment.

Yidong Ren, Wei Sun, Jialuo Du, Huaili Zeng, Younsuk Dong, Mi Zhang, Shigang Chen, Yunhao

Liu, Tianxing Li, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiCom 2024 [C3] LoRaTrimmer: Optimal Energy Condensation with Chirp Trimming for LoRa Weak Signal

Decoding.

Jialuo Du, Yunhao Liu, Yidong Ren, Li Liu, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiSys 2024 [C4] ChirpTransformer: Versatile LoRa Encoding for Low-power Wide-area IoT.

Yidong Ren\* (co-primary author), Chenning Li\*, Shuai Tong, Shakhrul Iman Siam, Mi Zhang, Jil-

iang Wang, Yunhao Liu, Zhichao Cao.

The 22nd ACM International Conference on Mobile Systems, Applications, and Services

Acceptance ratio: 16.35%

SenSys 2024 [C5] PiezoBuds: Piezo-Aided Secure Earbuds with Practical Speaker Authentication.

Gen Li\*, Huaili Zeng\*, Hanqing Guo, Yidong Ren, Aiden Dixon, Zhichao Cao and Tianxing Li.

The 22nd ACM Conference on Embedded Networked Sensor Systems.

Acceptance ratio: 18.53%

MobiHoc 2023 [C6] SRLoRa: Neural-enhanced LoRa Weak Signal Decoding with Multi-gateway Super Resolution.

Jialuo Du, Yidong Ren, Zhuizhu, Chenning Li, Zhichao Cao, Qiang Ma, Yunhao Liu.

The 24th International Symposium on Theory, Algorithmic Foundations, and Protocol Design for

Mobile Networks and Mobile Computing

Acceptance ratio: 22.06%

INFOCOM 2023 [C7] Prism: High-throughput LoRa Backscatter with Non-linear Chirps.

Yidong Ren, Puyu Cai, Jinyan Jiang, Jialuo Du, Zhichao Cao.

IEEE Conference on Computer Communications, 2023

Acceptance ratio: 19.21%

ICNP 2022 [C8] Is Lorawan Really Wide? Fine-grained LoRa Link-level Measurement in An Urban Environ-

ment

Yidong Ren\* (co-primary author), Li Liu\*, Chenning Li\*, Zhichao Cao and Shigang Chen.

The 30th IEEE International Conference on Network Protocols.

Acceptance ratio: 21.43%

<sup>\*</sup> denotes equal contribution, \_ are students I mentor

# JOURNAL PUBLICATIONS

ToN [J1] Morph: ChirpTransformer-based Encoder-decoder Co-design for Reliable LoRa Communication.

Yidong Ren, Maolin Gan, Mi Zhang, Shigang Chen, Zhichao Cao.

Under review of IEEE/ACM Transactions on Networking

TMC [J2] Channel Adapted Antenna Augmentation for Improved Wi-Fi Throughput.

Yanbo Zhang, Weiping Sun, Yidong Ren, Sung-ju Lee, Mo Li.

IEEE Transactions on Mobile Computing, 2022.

# **BENCKMARK**

ICLR ML4IoT

NELoRa-Bench: A Benchmark for Neural-enhanced LoRa Demodulation.

Jialuo Du, Yidong Ren, Mi Zhang, Yunhao Liu and Zhichao Cao.

International Conference on Learning Representations Workshop on Machine Learning for IoT,

2023. Oral 2/

#### **DEMO**

MobiCom 2024

Demeter-Demo: Demonstrating Cross-soil LPWAN with Low-cost Signal Polarization Alignment. **Yidong Ren**, Wei Sun, Jialuo Du, Huaili Zeng, Younsuk Dong, Mi Zhang, Shigang Chen, Yunhao

Liu, Tianxing Li, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking (Demo)

#### INTERNSHIP EXPERIENCE

Qualcomm, WLAN System Team. Santa Clara, CA, USA

06/2024 - 09/2024

Research on DNN-assisted Wi-Fi CSI localization and Deep reinforcement learning for Wi-Fi roaming.

Nanyang Technological University, WADNS Group, Singapore

07/2019 - 10/2019

Channel adaptive Wi-Fi intelligent antenna selection system. Advisor: Mo Li

#### TEACHING EXPERIENCE

Michigan State University, Department of Computer Science and Engineering

Teaching Assistant

CSE 220 — Programming in C

Spring 2022, Spring 2023, Spring 2024

CSE 891 — AIoT: Artificial Intelligence in the Edge

Fall 2022

**Guest Lecturer** 

• CSE 891 — AIoT: Artificial Intelligence in the Edge

Fall 2023

#### **ACADEMIC SERVICE**

<b>Programm Con</b>	nmittee	Οİ
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ACM MobiCom Artifact Evaluation     2024
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ACM MobiSys Artifact Evaluation

2024

ACM SenSys Artifact Evaluation
 IEEE International Conference on Parallel and Distributed Systems (ICPADS)

2024

2024

2024

# Invited Journal Reviewer of

<ul> <li>IEEE/ACM Transactions on Networking</li> </ul>	2023-2024
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IEEE Transactions on Mobile ComputingACM Transactions on Sensor Network

2022-2024

#### Conference Reviewer of

• IEEE International Symposium on Dynamic Spectrum Access Networks (DySpan)

2022-2023

• EAI MobiQuitous

2022

# **MENTORSHIP**

Puyu Cai 02/2022-12/2022

Now: Master student at Computer Science Department, New York University

Khang Nguyen and Nam Nguyen

03/2023 - Present

Now: Honor College, Michigan State University

#### AWARDS

Student Travel Grant, ACM MobiCom	2024
Student Travel Grant, ACM MobiSys	2024
Student Travel Grant, ACM MobiHoc	2023
Student Travel Grant, IEEE ICNP	2022

#### GRANTS EXPERIENCE

I assisted in the preparation of proposals for the following research grants:

NSF: LoRa Enabled Space-air-ground Integrated Networks for Next-Generation Agricultural IoT.

Award number 2338976.

**NSF:** Towards High-Performing LoRa with Embedded Intelligence on the Edge.

Award number 2312674.

# **TALKS**

ACM MobiSys 2024, Tokyo, Japan	06/2024
Conference Presentation	

"ChirpTransformer: Versatile LoRa Encoding for Low-power Wide-area IoT"

Tsinghua University, Beijing, China 06/2024

**Invited Talk** 

"Reliable Cross-soil LPWAN for agricultural IoT"

IEEE INFOCOM 2023, New York City, USA 05/2023

Conference Presentation

"Prism: High-throughput LoRa Backscatter with Non-linear Chirps"

# REFERENCES

# 1. Zhichao Cao (Advisor)

Michigan State University

The Hong Kong University of Science and Technology

Department of Computer Science and Engineering,

Department of Computer Science and Engineering **Assistant Professor** 

# **NSF CAREER AWARDEE**

Email: caozc@msu.edu Phone: +1-517-353-3148

#### 2. Shigang Chen University of Florida

Professor Department of Computer & Information of Science & Engineering

#### **IEEE Fellow, ACM Distinguished Member**

Email: sgchen@cise.ufl.edu Phone: +1-352-214-9215

# Professor IEEE Fellow, ACM Distinguished Member

Email: lim@cse.ust.hk

Phone: +852 2358 7107

# 4. Yunhao Liu

3. Mo Li

Tsinghua University Professor, Dean Global Innovation Exchange

**ACM Fellow, IEEE Fellow** Email: yunhao@tsinghua.edu.cn

Phone: +1-517-2495-850